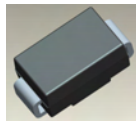


Features

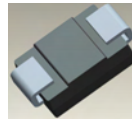
- 3.0W Power Dissipation
- Ideally Suited for Automated Assembly
- 6.2V - 39V Nominal Zener Voltage Range
- Standard V_Z Tolerance is $\pm 5\%$
- ESD Rating of Class 3 ($>16kV$) per Human Body Model
- **Lead Free Finish/RoHS Compliant (Note 1)**
- **Green Molding Compound (No Halogen and Antimony)**

Mechanical Data

- Case: SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Weight: 0.096 grams (approximate)



Top View



Bottom View

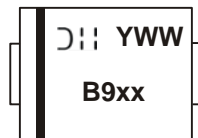
Ordering Information (Note 2)

Device*	Packaging	Shipping
1SMB59xxB-13	SMB	3000/Tape & Reel

*x = Device Voltage, e.g., 1SMB5920B-13.

- Notes:
1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
 2. For packaging details, go to our website at <http://www.diodes.com>.

Marking Information



B9xx = Product type marking code
(See Electric Characteristics Table)
DII = Manufacturers' code marking
YWW = Date code marking
Y = Last digit of year (ex: 1 for 2011)
WW = Week code (01 - 53)

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Forward Voltage @I _F = 200mA	V _F	1.5	V
Zener Current (see Table page 2)	I _{ZM}	P _D / V _Z	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation @T _L = 75°C	P _D	3.0	W
Derate Above 75°C (Note 2)		40	mW/°C
Thermal Resistance - Junction to Terminal (Note 2)	R _{θJT}	25	°C/W
Power Dissipation @T _A = 25°C	P _D	550	mW
Derate Above 25°C (Note 2)		4.4	mW/°C
Thermal Resistance - Junction to Ambient (Note 2)	R _{θJA}	228	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Type Number	Marking Code	Zener Voltage Range (Note 4)			Test Current	Maximum Zener Impedance (Note 5)			Maximum Reverse Current (Note 4)		I _{ZM} Max	
		V _Z @ I _{ZT}				I _{ZT}	Z _{ZT} @ I _{ZT}	Z _{ZK} @ I _{ZK}		I _R @ V _R		
		Min (V)	Typ (V)	Max (V)				Ω	Ω	mA		μA
1SMB5920B	B920	5.89	6.2	6.51	60.5	2	200	1	5	4	241	
1SMB5921B	B921	6.46	6.8	7.14	55.1	2.5	200	1	5	5.2	220	
1SMB5922B	B922	7.12	7.5	7.88	50	3	400	0.5	5	6	200	
1SMB5923B	B923	7.79	8.2	8.61	45.7	3.5	400	0.5	5	6.5	182	
1SMB5924B	B924	8.64	9.1	9.56	41.2	4	500	0.5	5	7	164	
1SMB5925B	B925	9.5	10	10.5	37.5	4.5	500	0.25	5	8	150	
1SMB5926B	B926	10.45	11	11.55	34.1	5.5	550	0.25	1	8.4	136	
1SMB5927B	B927	11.4	12	12.6	31.2	6.5	550	0.25	1	9.1	125	
1SMB5928B	B928	12.35	13	13.65	28.8	7	550	0.25	1	9.9	115	
1SMB5929B	B929	14.25	15	15.75	25	9	600	0.25	1	11.4	100	
1SMB5930B	B930	15.2	16	16.8	23.4	10	600	0.25	1	12.2	93	
1SMB5931B	B931	17.1	18	18.9	20.8	12	650	0.25	1	13.7	83	
1SMB5932B	B932	19	20	21	18.7	14	650	0.25	1	15.2	75	
1SMB5933B	B933	20.9	22	23.1	17	17.5	650	0.25	1	16.7	68	
1SMB5934B	B934	22.8	24	25.2	15.6	19	700	0.25	1	18.2	62	
1SMB5935B	B935	25.65	27	28.35	13.9	23	700	0.25	1	20.6	55	
1SMB5936B	B936	28.5	30	31.5	12.5	28	750	0.25	1	22.8	50	
1SMB5937B	B937	31.35	33	34.65	11.4	33	800	0.25	1	25.1	45	
1SMB5938B	B938	34.2	36	37.8	10.4	38	850	0.25	1	27.4	41	
1SMB5939B	B939	37.05	39	40.95	9.6	45	900	0.25	1	29.7	38	

- Notes:
- Device mounted on FR-4 PCB; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com>.
 - Short duration pulse test used to minimize self-heating effect.
 - ZENER IMPEDANCE (Z_Z) DERIVATION Z_{ZT} and Z_{ZK} are measured by dividing the ac voltage drop across the device by the ac current applied. The specified limits are for I_{Z(ac)} = 0.1 I_{Z(dc)} with the ac frequency = 60 Hz.

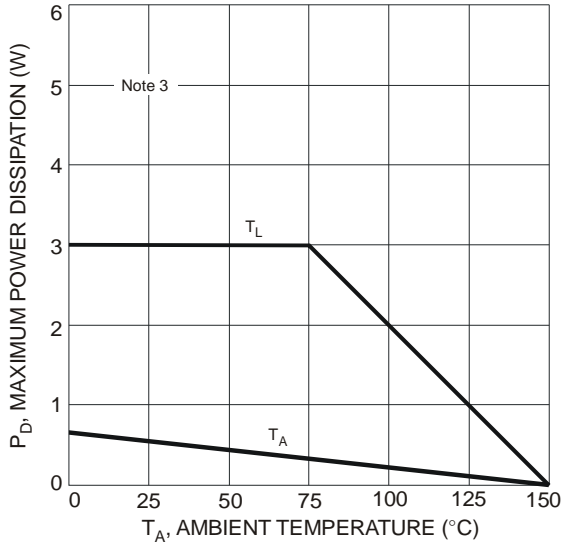


Fig. 1 Power Dissipation vs. Ambient Temperature

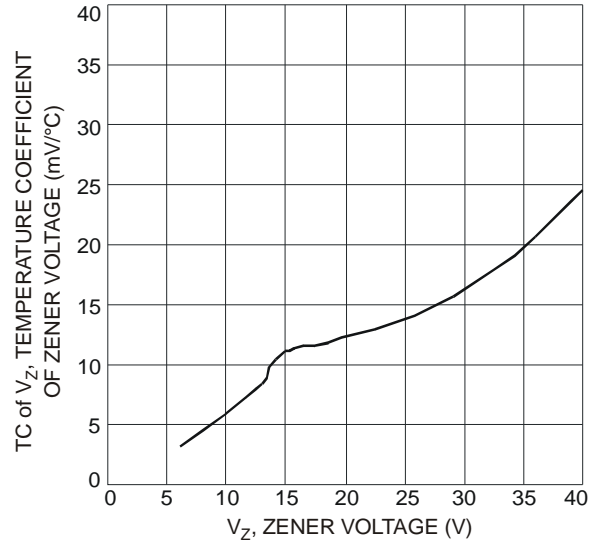


Fig. 2 Typical Temperature Coefficient of Zener Voltage vs. Zener Voltage

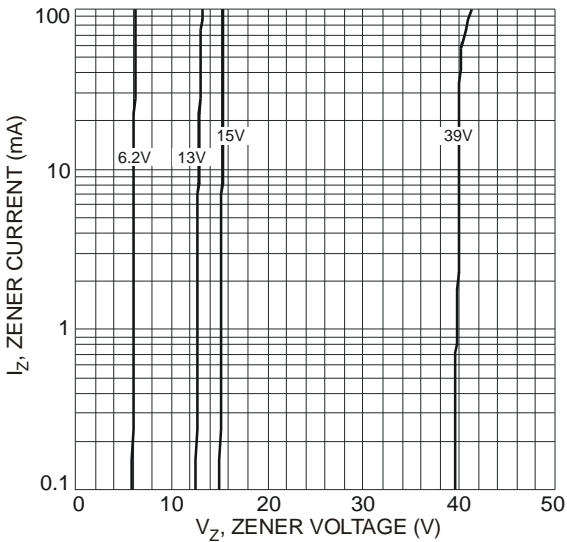


Fig. 3 Typical Zener Breakdown Characteristics

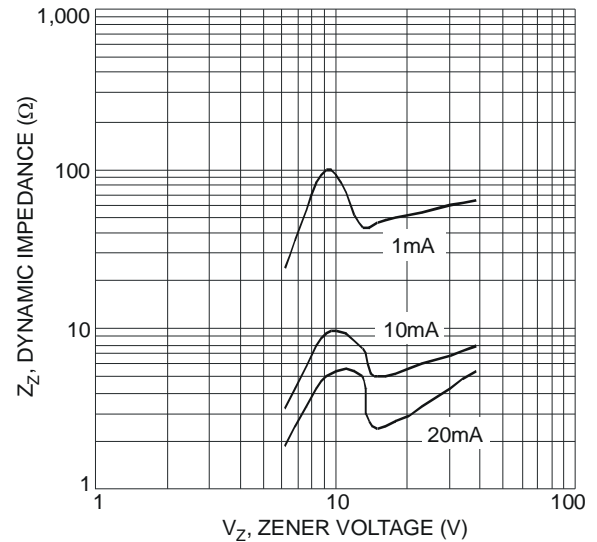


Fig. 4 Effect of Zener Voltage

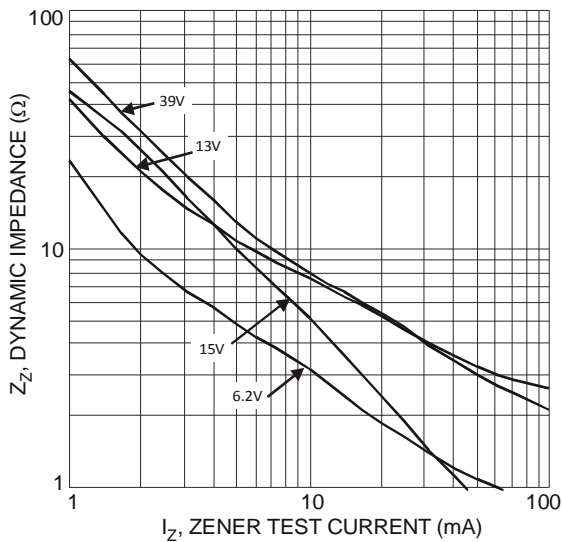


Fig. 5 Effect of Zener Current

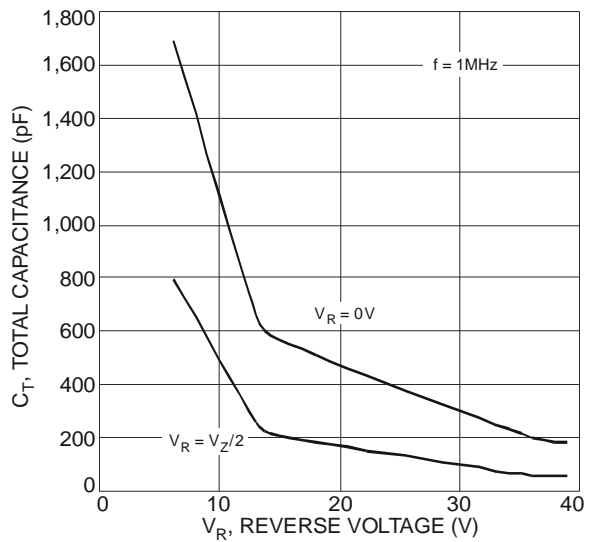


Fig. 6 Typical Total Capacitance vs. Reverse Voltage

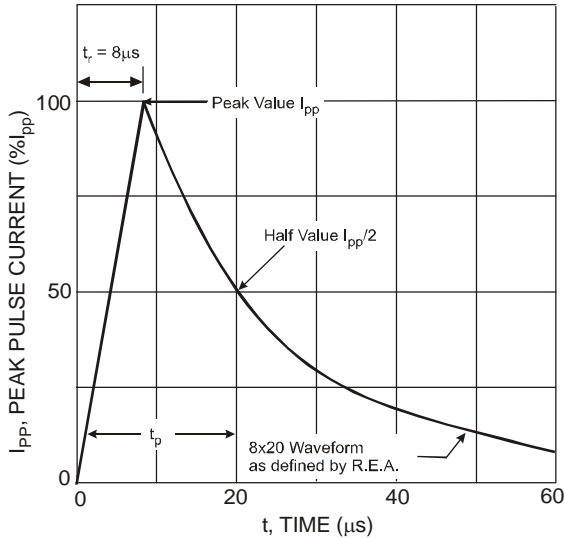


Fig. 7 Pulse Waveform

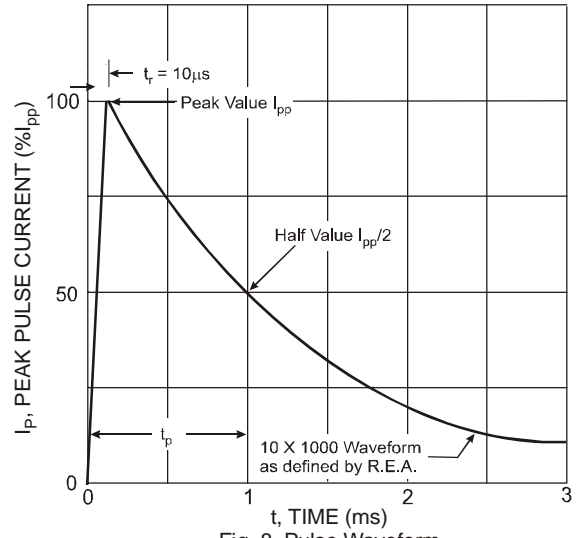


Fig. 8 Pulse Waveform

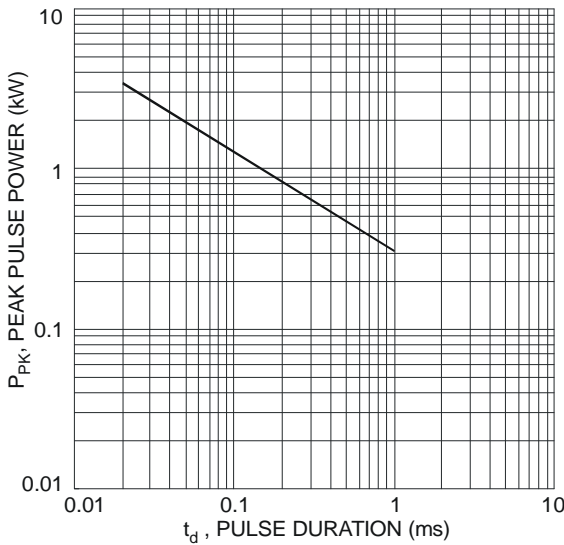
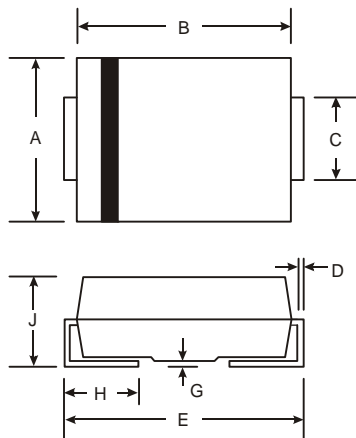


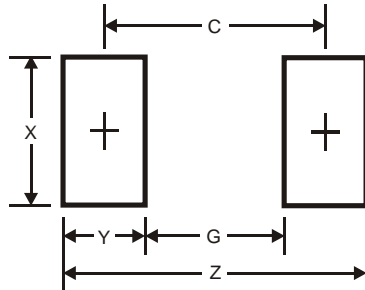
Fig. 9 Max. Peak Pulse Power vs. Pulse Duration

Package Outline Dimensions



SMB		
Dim	Min	Max
A	3.30	3.94
B	4.06	4.57
C	1.96	2.21
D	0.15	0.31
E	5.00	5.59
G	0.05	0.20
H	0.76	1.52
J	2.00	2.50
All Dimensions in mm		

Suggested Pad Layout



Dimensions	Value (in mm)
Z	6.8
G	1.8
X	2.3
Y	2.5
C	4.3

IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or
2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2011, Diodes Incorporated

www.diodes.com



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.